TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD

Form 6-K June 09, 2003

1934 Act Registration No. 1-14700

SECURITIES AND EXCHANGE COMMISSION
Washington, DC 20549

FORM 6-K

REPORT OF FOREIGN PRIVATE ISSUER PURSUANT TO RULE 13a-16 OR 15d-16 OF THE SECURITIES EXCHANGE ACT OF 1934

For the month of June 2003

Taiwan Semiconductor Manufacturing Company Ltd.

(Translation of Registrant's Name Into English)

No.121 Park Avenue III
Science-Based Industrial Park
Hsin-chu, Taiwan
(Address of Principal Executive Offices)

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F X Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes No X

(If "Yes" is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2 (b): 82: .)

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company Ltd.

Date: June 9, 2003 By /s/ Harvey Chang

II. Oh o a

Harvey Chang

Senior Vice President & Chief Financial Officer

TSMC Monthly Sales Report - May 2003

Hsinchu, Taiwan, June 9, 2003 - Taiwan Semiconductor Manufacturing Company Ltd. ("TSMC" or "the Company") (TAIEX: 2330, NYSE: TSM), today announced that net sales for May 2003 totaled NT\$16,812 million, representing a 10.1 percent increase over April 2003. On a year-over-year basis, net sales for May 2003 increased 10.6 percent. Revenues for January through May 2003 totaled NT\$71,401 million, an increase of 10.9 percent over the same period in 2002.

Mr. Harvey Chang, TSMC spokesperson and senior vice president, noted that compared to April 2003, customer demand continues to grow. The Company's sales revenues for May 2003 increased as a result of increased wafer shipment and better product mix.

#

Sales Report: (Unit: NT\$ million)

Net Sales	2003(1)	2002	Growth
May	16,812	15,201	10.6%
January through May	71,401	64,357	10.9%

(1): Year 2003 figures have not been audited.

TSMC Spokesperson:

Mr. Harvey Chang Senior Vice President

Tel: 886-3-563-6688 Ext: 2075

For further information, please contact:

E-mail: jhtzeng@tsmc.com.tw E-Mail: jhchoua@tsmc.com.tw

Mr. Jesse Chou

PR Department Manager, TSMC

Tel: 886-3-666-5028 (O)

886-928-882-607 (Mobile)

Fax: 886-3-567-0121 Tel:886-3-666-5029 (O) 886-932-113-258(Mobile)

Fax:03-5670121

Ms. Shan-Shan Guo PR Manager, TSMC

Tel:886-3-666-5033(O) 886-939-059-246 (Mobil

Fax:03-5670121

Email: ssquo@tsmc.com.tw

Taiwan Semiconductor Manufacturing Company Limited June 09, 2003

This is to report the changes or status of 1) Sales volume 2) funds lent to other

parties 3) Endorsements and quarantees 4) Financial derivative transactions for the period of May 2003.

1 '	20162	770] 11ma	/NTS ·	Thousand)
Ι.) Sales	vorume	(INT 5:	Illousaliu)

				,370)	347,120
TSMC		58,721,466		_	_
					Bal. As of period en
2) Funds lent	to other part:				
				64,356,854	
May 	Net sales		16,811,729	15,200,909	1,610,
				66,500,697	-1,800,
May 	Invoice ar	mount	14,284,446	15,393,506	-1,109,
Period	Items		2003	2002	Chang

Limi	t of endorsements	May	Bal. As o
TSMC	59,768,660	(93,160)	
TSMC's subsidiaries	N/A	0	
TSMC endorses for subsidiaries		(93,160)	
TSMC's subsidiaries endorse for TSMC		0	
TSMC endorses for PRC companies		0	
TSMC's subsidiaries endorse for PRC		0	

4) Financial derivative transactions

Underlying assets / liabilities	ssets / liabilities Liabilities: Y		
		EUR:	
	Assets:	US\$	

a-1. Hedging purpose(for assets / liabilities denominated in foreign currencies)

Financial instruments		FX forw
Realized profit (loss)		(
a-2. Hedging purpose (for the position of f		
Underlying assets / liabilities	Liabilities:	NT\$
Financial instruments		Inter
Realized profit (loss)		

b. Trading purpose: None.

TSMC Signed Investment Agreements with Shanghai Songjiang Government

Taiwan Semiconductor Manufacturing Company (TSMC) has signed investment agreements with Shanghai Songjiang Government on June 8th, 2003. According to the agreements, TSMC plans to set up an 8-inch fab using 0.25-micron and 0.35-micron process technologies in the Songjiang Science Park in Shanghai to provide foundry services in Mainland China.

In the premise of getting the approval from Taiwan government and having enough customer demands, the 8-inch fab is expected to start small volume production by the end of 2004.

TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LIMITED

This is to report the grant of Employee Stock Options in June 2003.

ESOP Granted	June 2003
Approval Date by the Securities and Futures Commission	06/25/2002
Issue (Grant) Date	06/06/2003
Number of Shares Issued	23,090,550
Percentage of Issued Shares to Outstanding Common Shares	0.12399%
Source of Option Shares	New Common Share
Grant Price Per Shares	NT\$58.5
Option Duration	10 years
Vesting Schedule	2nd Year: up to 50% 3rd Year: up to 75%

4th Year: up to 100%